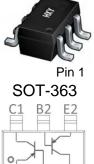


FEATURES

Epitaxial planar die construction. Ideal for low power amplification and switching.

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MMDT3906	SOT-363	K3N	3000



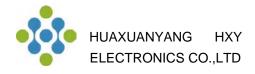
MAXIMUM RATINGS (Ta=25 unless otherwise noted)

MAXIMUN	I RATINGS (Ta=25 unless otherwise not	ted)	Pin 1	
Symbol	Parameter	Value	Unit	
V _{CBO}	Collector-Base Voltage	-40	V	
V _{CEO}	Collector-Emitter Voltage	-40	V	
V _{EBO}	Emitter-Base Voltage	-5	V	
lc	Collector Current	-200	mA	
Pc	Collector Power Dissipation	200	mW	
R _{ØJA}	Thermal Resistance From Junction To Ambient	625	°C/W	
T _J ,T _{stg}	Operation Junction And Storage Temperature Range	-55~+150	°C	

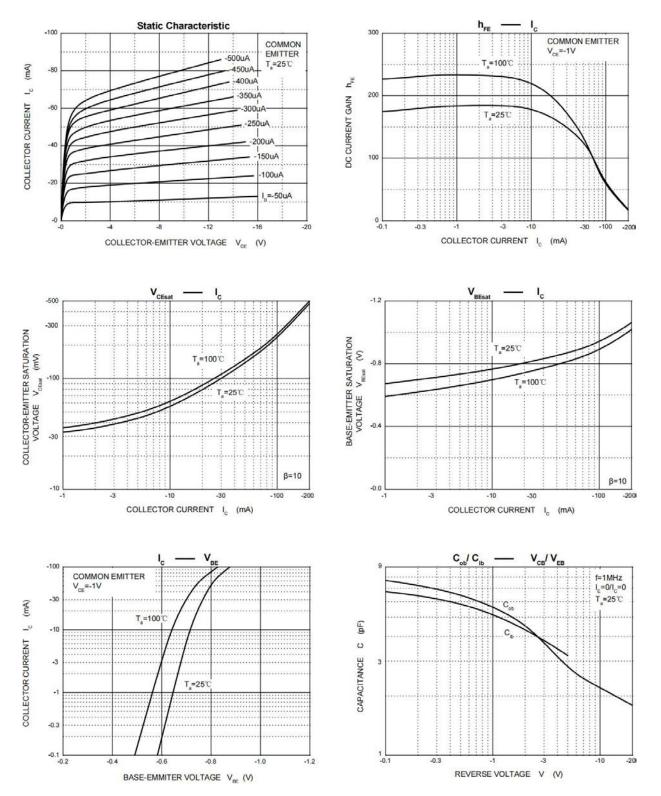
ELECTRICAL CHARACTERISTICS(Ta=25 unless otherwise noted)

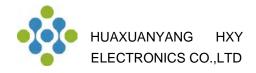
Symbol	Parameter Test conditions		Min	Тур	Max	Unit
V _{(BR)CBO} *	Collector-base breakdown voltage	I _C =-10μΑ, I _E =0	-40			V
V _{(BR)CEO} *	Collector-emitter breakdown voltage	I _C =-1mA, I _B =0 -40				V
V _{(BR)EBO} *	Emitter-base breakdown voltage	I _E =-10μA, I _C =0 -5				V
I _{CEX} *	Collector cut-off current	V _{CE} =-30V, V _{EB(off)} =-3V			-50	nA
I _{CBO}	Collector cut-off current	V _{CB} =-40V, I _E =0			-100	nA
I _{EBO}	Base cut-off current	V _{EB} =-5V,I _E =0			-50	nA
h _{FE} (1)*	DC current gain(1)	V _{CE} =-1V, I _C =-100 µ A	60			
h _{FE} (2)*	2)* DC current gain(2) V _{CE} =-1V, I _C =-1mA		80			
h _{FE} (3)*	* DC current gain(3) V _{CE} =-1V, I _C =-10mA		100		300	
h _{FE} (4)*	DC current gain(4)	V _{CE} =-1V, I _C =-50mA				
h _{FE} (5)*	DC current gain(5)	V _{CE} =-1V, I _C =-100mA	30			
\/ *		I _C =-10mA, I _B =-1mA			-0.25	V
V _{CE(sat)} *	Collector-emitter saturation voltage	I _C =-50mA, I _B =-5mA			-0.4	V
\/ *		I _C =-10mA, I _B =-1mA	-0.65		-0.85	V
V _{BE(sat)} *	Base-emitter saturation voltage	I _C =-50mA, I _B =-5mA			-0.95	V
f⊤	Transition frequency	V _{CE} =-20V, I _C =-10mA, f=100MHz	250			MHz
Cob	Collector output capacitance	V _{CB} =-5V, I _E =0, f=1MHz			4.5	pF
NF	Noise figure	VCE=-5V,Ic=-0.1mA,f=1kHz,Rg=1KΩ			4	dB
t _d	Delay time	V _{CC} =-3V, V _{BE(off)} =-0.5V,			35	ns
tr	Rise time	I _C =-10mA, I _{B1} =I _{B2} =-1mA			35	ns
ts	Storage time	V _{cc} =-3V, I _c =-10mA,			225	ns
t _f Fall time		I _{B1} =I _{B2} =-1mA			75	ns

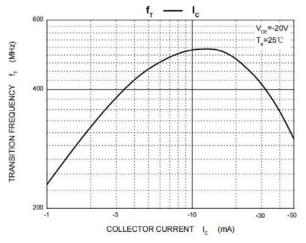
*Pulse test: pulse width ≤300µs, duty cycle≤ 2.0%.

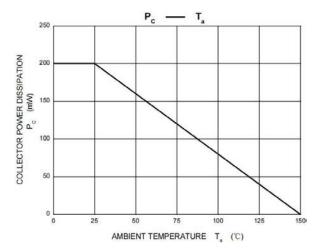


Typical Characteristics

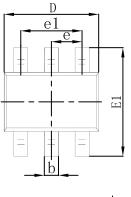


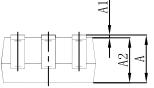


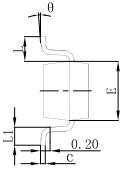




SOT-363 Package Outline Dimensions

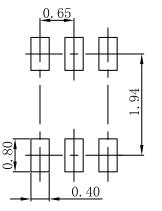






Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	0.900	1.100	0.035	0.043	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.000	0.035	0.039	
b	0.150	0.350	0.006	0.014	
С	0.100	0.150	0.004	0.006	
D	2.000	2.200	0.079	0.087	
E	1.150	1.350	0.045	0.053	
E1	2.150	2.400	0.085	0.094	
е	0.650 TYP		0.026 TYP		
e1	1.200	1.400	0.047	0.055	
L	0.525 REF		0.021 REF		
L1	0.260	0.460	0.010	0.018	
θ	0°	8°	0°	8°	

SOT-363 Suggested Pad Layout



Note:

1.Controlling dimension:in millimeters.

2.General tolerance:± 0.05mm.

3. The pad layout is for reference purposes only.



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